IGBT with Monolithic Reverse Conducting Diode

This Insulated Gate Bipolar Transistor (IGBT) features robust and cost effective Field Stop (FS2) trench construction with a monolithic RC Diode. It provides a cost effective Solution for applications where diode losses are minimal. The IGBT is optimized for low conduction losses (low V_{CEsat}) and is well suited for resonant or soft switching applications.

Features

- Extremely Efficient Trench with Fieldstop Technology
- Low Conduction Design for Soft Switching Application
- Reduced Power Dissipation in Inducting Heating Application
- Reliable and Cost Effective Single Die Solution
- This is a Pb–Free Device

Typical Applications

- Inductive Heating
- Air Conditioning PFC
- Welding

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	650	V
Collector current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	Ic	80 40	A
Pulsed collector current, T_{pulse} limited by $T_{Jmax},10~\mu s$ pulse, V_{GE} = 15 V	I _{CM}	160	A
Diode forward current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	Ι _F	80 40	A
Diode pulsed current, T_{pulse} limited by $T_{Jmax},10~\mu s$ pulse, V_{GE} = 0 V	I _{FM}	160	A
Power Dissipation @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	P _D	405 202	W
Operating junction temperature range	TJ	-40 to +175	°C
Storage temperature range	T _{stg}	-55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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40 A, 650 V V_{CEsat} = 1.55 V E_{off} = 0.42 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB40N65IHRTG	TO–3P (Pb–Free)	30 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case	$R_{ ext{ heta}JC}$	0.37	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	·					
Collector–emitter breakdown voltage, gate–emitter short–circuited	V_{GE} = 0 V, I _C = 500 μ A	V _{(BR)CES}	650	-	_	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 40 A V _{GE} = 15 V, I _C = 40 A, T _J = 175°C	V _{CEsat}	-	1.55 1.95	1.7 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 350 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V, V_{CE} = 650 V$ $V_{GE} = 0 V, V_{CE} = 1200 V, T_{J} = 175^{\circ}C$	I _{CES}	-	_ 1.0	0.3 -	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V, V_{CE} = 0 V	I _{GES}	-	-	100	nA
DYNAMIC CHARACTERISTIC	·			•		
Input capacitance		C _{ies}	-	4628	-	pF
Output capacitance	V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz	C _{oes}	_	148	-	
Reverse transfer capacitance		C _{res}	-	126	-	
Gate charge total		Qg	-	190	-	nC
Gate to emitter charge	V_{CE} = 400 V, I _C = 40 A, V _{GE} = 15 V	Q _{ge}	-	38	-	
Gate to collector charge		Q _{gc}	-	90	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-off delay time	$T_J = 25^{\circ}C$	t _{d(off)}	-	197	-	ns
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $R_{g} = 10 \Omega$	t _f	-	74	-	
Turn-off switching loss	$V_{GE} = 0 V/15V$	E _{off}	_	0.42	-	mJ
Turn-off delay time	T _J = 175°C	t _{d(off)}	-	210	-	ns
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $R_{g} = 10 \Omega$	t _f	-	106	-	
Turn-off switching loss	$V_{GE} = 0 V / 15V$	E _{off}	_	0.7	-	mJ
DIODE CHARACTERISTIC						
Forward voltage	V _{GE} = 0 V, I _F = 40 A V _{GE} = 0 V, I _F = 40 A, T _J = 175°C	V _F	-	1.50 1.70	1.80 -	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.









Figure 21. IGBT Transient Thermal Impedance



Figure 22. Test Circuit for Switching Characteristics





MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS





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